

PS2841-4A,PS2841-4B

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WORLD'S SMALLEST CLASS, FOUR CHANNELS 12-PIN ULTRA SHRINK SOP PHOTOCOUPLER

DESCRIPTION

The PS2841-4A and PS2841-4B are optically coupled isolators containing GaAs light emitting diodes and NPN silicon phototransistors.

These products include four channels in a single package for high-density mounting applications.

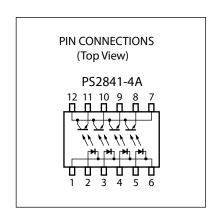
The PS2841-4A and PS2841-4B are the world's smallest class of photocouplers and realize about 50% reduction in mounting area compared with the PS280x and PS281x Series.

FEATURES

- Ultra small and thin package
 (12-pin ultra shrink SOP, Pin pitch 0.8 mm, 4.4 (L) × 5.6 (W) × 2.5 (H))
- Common lead PS2841-4A: cathode, collector common PS2841-4B: anode, collector common
- High current transfer ratio (CTR = 200% TYP. @ I_F = 1mA)
- High isolation voltage (BV = 1 500 Vr.m.s.)
- · Pb-Free product
- Ordering number of tape product:

PS2841-4A-F3: 2 500 pcs/reel PS2841-4B-F3: 2 500 pcs/reel

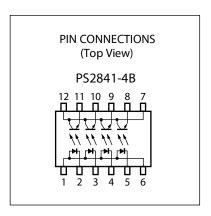
- Safety standards
 - UL approved: UL1577, Single protecion



Channel	Anode	Cathode	Emitter	Collector
1 ch	2	1, 6 common	11	7, 12 common
2 ch	3	1, 6 common	10	7, 12 common
3 ch	4	1, 6 common	9	7, 12 common
4 ch	5	1, 6 common	8	7, 12 common

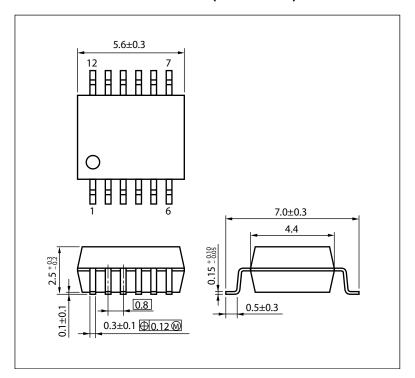
APPLICATIONS

- Programmable logic controllers (PLCs)
- Input and output for function automation
- · Hybrid IC



Channel	Anode	Cathode	Emitter	Collector
1 ch	1, 6 common	2	11	7, 12 common
2 ch	1, 6 common	3	10	7, 12 common
3 ch	1, 6 common	4	9	7, 12 common
4 ch	1, 6 common	5	8	7, 12 common

PACKAGE DIMENSIONS (UNIT: mm)

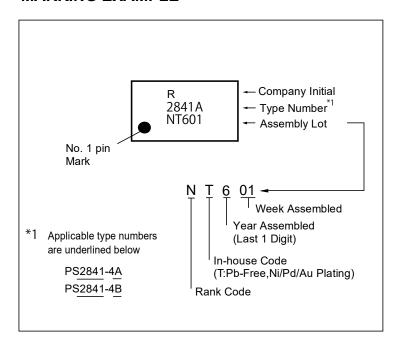


PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)		
Air Distance	4.0 mm		
Creepage Distance	4.0 mm		
Isolation Thickness	0.4 mm		

Weight (12-pin SSOP): 0.14 g (typ.)

MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *1
PS2841-4A	PS2841-4A-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS2841-4A
PS2841-4A-F3	PS2841-4A-F3-AX		Embossed Tape 2 500 pcs/reel	(UL approved)	
PS2841-4B	PS2841-4B-AX		20 pcs (Tape 20 pcs cut)		PS2841-4B
PS2841-4B-F3	PS2841-4B-F3-AX		Embossed Tape 2 500 pcs/reel		

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	lf	20	mA/ch	
	Reverse Voltage	VR	6	V	
	Power Dissipation Derating	⊿ IF /°C	0.2	mA /°C	
	Peak Forward Current*1	IFP	0.5	A/ch	
Transistor	Collector to Emitter Voltage	Vceo	70	V	
	Emitter to Collector Voltage	VECO	5	V	
	Collector Current	lc	20	mA/ch	
	Power Dissipation Derating	⊿Pc/°C	0.4	mW/°C	
	Power Dissipation	Pc	40	mW/ch	
Isolation Voltage*2		BV	1 500	Vr.m.s.	
Operating Ambient Temperature		TA	-40 to +100	°C	
Storage Temperature		T _{stg}	-55 to +125	°C	

Notes: *1. PW = 100 μ s, Duty Cycle = 1%

*2. AC voltage for 1 minute at T_A= 25°C, RH = 60% between input and output. Pins 1-6 shorted together, 7-12 shorted together.

ELECTRICAL CHARACTERISTICS (TA = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I _F = 1 mA	0.9	1.1	1.2	V
	Reverse Current	lr	V _R = 5 V			10	μΑ
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		15		pF
Transistor	Collector to Emitter Current	Iceo	IF = 0 mA, VcE = 24 V			100	nA
Coupled	Current Transfer Ratio (Ic/IF)	CTR	IF = 1 mA, VcE = 0.4 V	100	200	400	%
	Optical Leakage Current*1 (1 to 2-ch, 2 to 3-ch, 3 to 4-ch)	lι	I _F = 5 mA, V _{CE} = 24 V			100	nA
	Collector Saturation Voltage	VCE (sat)	I _F = 1 mA, I _C = 0.2 mA		0.13	0.3	V
	Isolation Resistance	R _{I-O}	V _{I-O} = 1 kV _{DC}	10 ¹¹			Ω
	Isolation Capacitance	Сі-о	V = 0 V, f = 1 MHz		0.4		pF
	Turn-on Time *2	ton	$V_{CC} = 5 \text{ V}, \text{ I}_F = 1 \text{ mA}, \text{ RL} = 5 \text{ k}\Omega$		20		μs
	Turn-off Time *2	toff			110		

Notes: *1. The optically induced leakage current is current which can be measured at transistor if LED = "ON" and LED = "OFF".

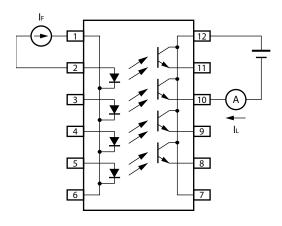
LED of channel 1 is switched to "ON".

At Tr-output of channel 2 a voltage is applied and one can measure a current between emitter and collector.

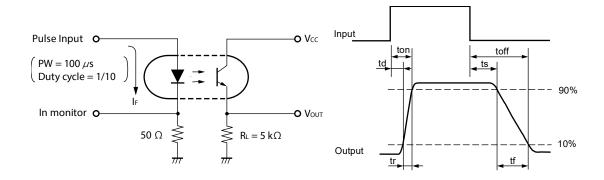
This is leakage current (at $I_F = 5$ mA, $V_{CEO} = 24$ V).

Measurement circuits for optical leakage current

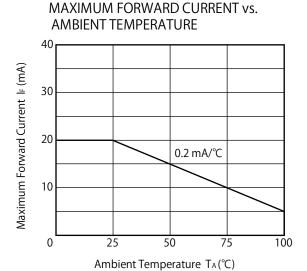
E.g.: In the case of 1 to 2-ch (PS2841-4A)



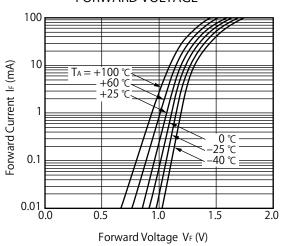
*2. Test circuit for switching time



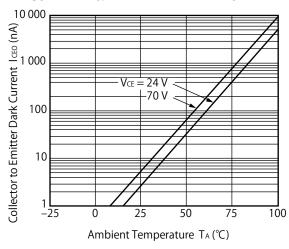
TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)



FORWARD CURRENT vs. FORWARD VOLTAGE

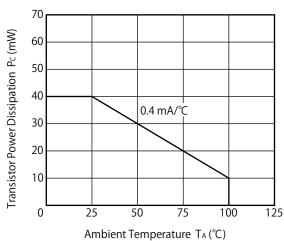


COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

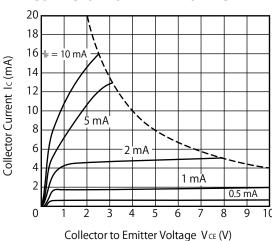


Remark The graphs indicate nominal characteristics.

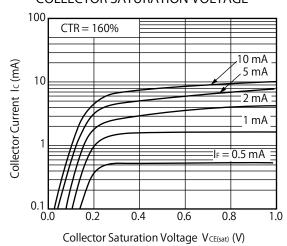
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE

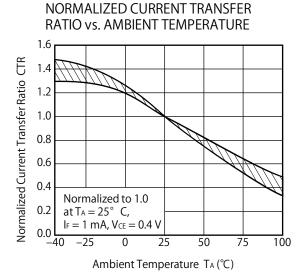


COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE

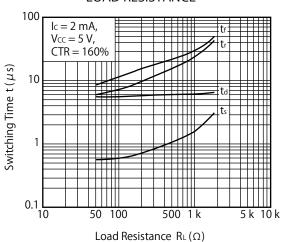


COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE

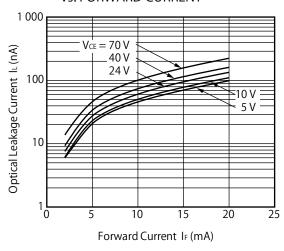






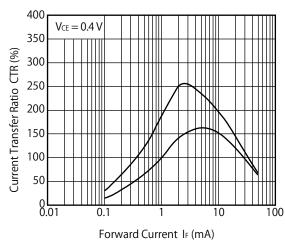


OPTICAL LEAKAGE CURRENT vs. FORWARD CURRENT

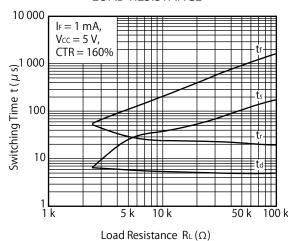


Remark The graphs indicate nominal characteristics.

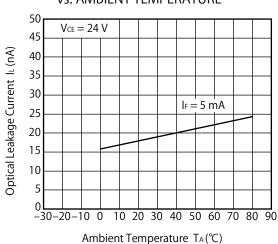
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



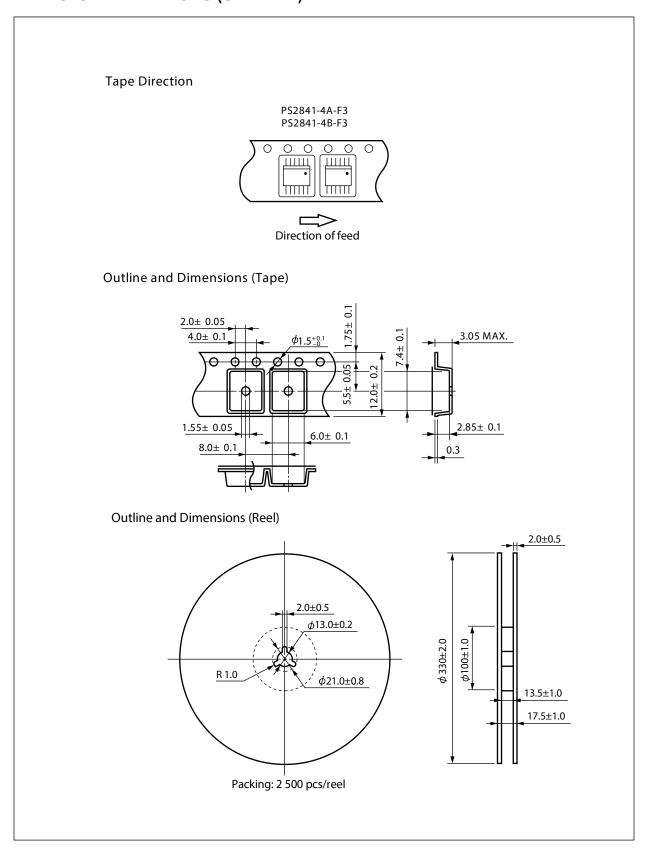
SWITCHING TIME vs. LOAD RESISTANCE



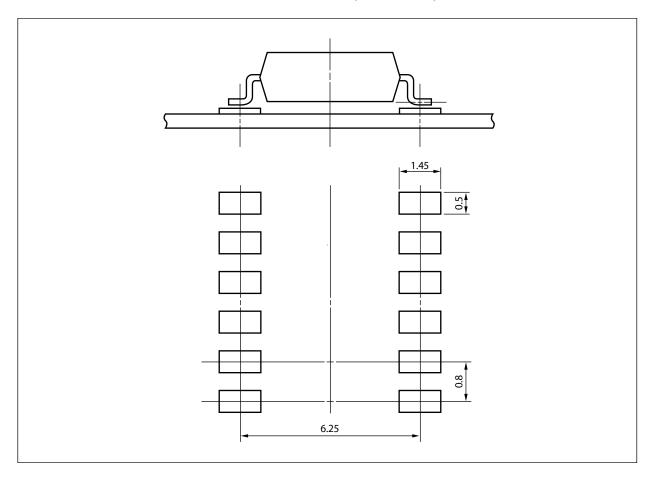
OPTICAL LEAKAGE CURRENT vs. AMBIENT TEMPERATURE



TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

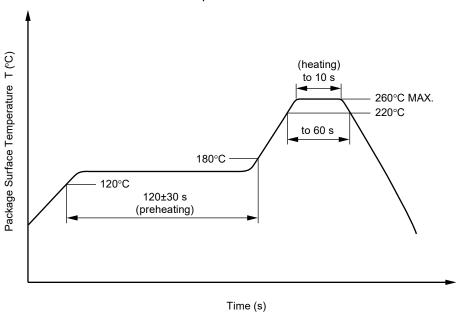
- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature 260°C or below (package surface temperature)
 - · Time of peak reflow temperature 10 seconds or less Time of temperature higher than 220°C 60 seconds or less
 - Time to preheat temperature from 120 to 180°C 120±30 s
 - Number of reflows
 - Flux

Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of

0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

 Time 10 seconds or less

 Preheating conditions 120°C or below (package surface temperature)

 Number of times One (Allowed to be dipped in solder including plastic mold portion.) Rosin flux containing small amount of chlorine (The flux with a maximum Flux

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

 Peak Temperature (lead part temperature) 350°C or below Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100°C
- (4) Cautions
 - Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

• Do not use fixing agents or coatings containing halogen-based substances.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.
- 3. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 4. Do not use fixing agents or coatings containing halogen-based substances.

Caution G

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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Renesas Electronics Corporation TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

Renesas Electronics America Inc. 1001 Murphy Ranch Road, Milpitas, CA 95035, U.S.A. Tel: +1-408-432-8888, Fax: +1-408-434-5351

Renesas Electronics Canada Limited reet, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3

9251 Yonge Street, St Tel: +1-905-237-2004

Renesas Electronics Europe GmbH Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
Room 101-T01, Floor 1, Building 7, Yard No. 7, 8th Street, Shangdi, Haidian District, Beijing 100085, China Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.

Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai 200333, China Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong Tel: +852-2265-6688, Fax: +852 2886-9022 Renesas Electronics Hong Kong Limited

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd. 80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949 Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit No 3A-1 Level 3A Tower 8 UOA Business Park, No 1 Jalan Pengaturcara U1/51A, Seksyen U1, 40150 Shah Alam, Selangor, Malaysia Tel: +60-3-5022-1288, Fax: +60-3-5022-1290

Renesas Electronics India Pvt. Ltd. No.777C, 100 Feet Road, HAL 2nd Stage, Indiranagar, Bangalore 560 038, India Tel: +91-80-67208700

Renesas Electronics Korea Co., Ltd. 17F, KAMCO Yangjae Tower, 262, Gangnam-daero, Gangnam-gu, Seoul, 06265 Korea Tel: +82-2-558-3737, Fax: +82-2-558-5338